

## PI13050Q1 TYPE

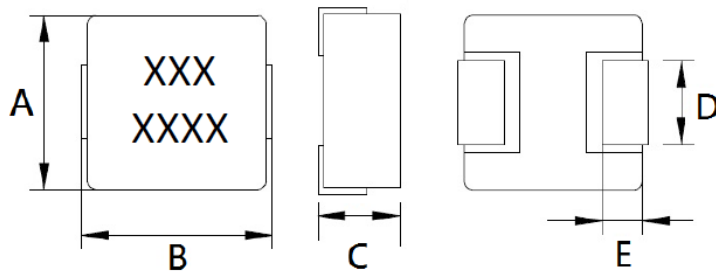
### ●FEATURE

1. Shielded construction · Frequency range up to 5MHz
2. AEC-Q200 Grade 1 qualified

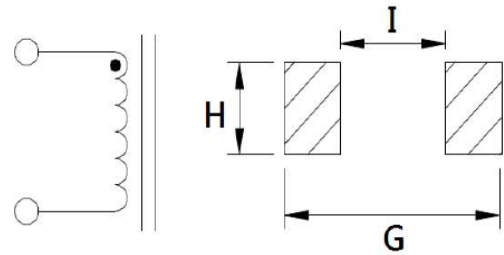
### ●Applications

1. Notebook, server application, High current power supplier

### ●Shape and Dimension



### ●Schematics and Land Patterns(mm)



A=12.90m/m Max ; B=14.00m/m Max ; C=5.00m/m Max. ; D=refer Note.7 ; E=2.20m/m Ref. ; G=14.00m/m Ref. ; H=5.15m/m Ref. ; I=7.60m/m Ref.

### ●Specification

P/N	L ( $\mu$ H)	RDC (m $\Omega$ ) Typical	RDC (m $\Omega$ )Max	Isat (A)	Irms (A)
PI13050Q1-R10M	0.10 $\pm$ 20%	0.53	0.60	118	55
PI13050Q1-R22M	0.22 $\pm$ 20%	0.64	0.80	110	51
PI13050Q1-R33M	0.33 $\pm$ 20%	0.85	1.10	80	42
PI13050Q1-R47M	0.47 $\pm$ 20%	1.10	1.30	65	38
PI13050Q1-R56M	0.56 $\pm$ 20%	1.30	1.50	55	36
PI13050Q1-R68M	0.68 $\pm$ 20%	1.50	1.70	54	34
PI13050Q1-R82M	0.82 $\pm$ 20%	2.00	2.30	53	31
PI13050Q1-1R0M	1.0 $\pm$ 20%	2.10	2.50	50	29
PI13050Q1-1R5M	1.5 $\pm$ 20%	3.40	4.10	48	23
PI13050Q1-2R2M	2.2 $\pm$ 20%	4.60	5.50	32	20
PI13050Q1-3R3M	3.3 $\pm$ 20%	7.70	9.20	32	15
PI13050Q1-4R7M	4.7 $\pm$ 20%	12.8	15.0	27	12
PI13050Q1-5R6M	5.6 $\pm$ 20%	14.0	16.5	22	11.5
PI13050Q1-6R8M	6.8 $\pm$ 20%	15.4	18.5	21	11
PI13050Q1-8R2M	8.2 $\pm$ 20%	18.9	22.5	18	9.5
PI13050Q1-100M	10 $\pm$ 20%	21.4	25.5	16	9.0

Note1. Measurement frequency of Inductance value : at 100KHz

Note2. Measurement ambient temperature of L, DCR and IDC : at 25°C

Note3. Isat: DC current at which the inductance drops 20%(typ) from its value without current

Note4. Irms: Average current for 40°C temperature rise from 25°C ambient(typical)

Note5. Inductance tolerance: M:  $\pm 20\%$

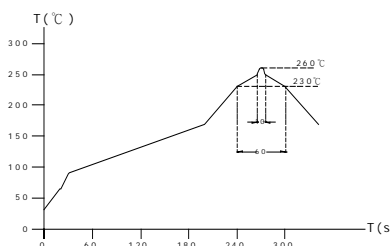
Note6. Packaging: Taping ; Quantity: 250 Piece/reel

Note7. D Dimension range: R10~2R2, D=4.0 $\pm$ 0.5mm ; 3R3~100M, D=4.7 $\pm$ 0.3 mm

## GENERAL CHARACTERISTICS

1. Operating temperature range: -55 TO + 125°C (Includes temperature when the coil is heated)
2. High temperature exposure(storage) refer MIL-STD-202 Method 108: 1000 hrs at rated operating temperature(e.g. 125°C). Part can be stored for 1000 hrs @125°C. Unpowered. Measurement at 24±4 hours after test conclusion.
3. Temperature cycling refer JESD22 Method JA-104: 1000 cycles(-55 TO + 125°C). Measurement at 24±4 hours after test conclusion. 30 min maximum dwell time at each temp. extreme. 1 min. maximum transition time.
4. Biased Humidity refer MIL-STD-202 Method 103: 1000 hours 85°C/85%RH. Unpowered. Measurement at 24±4 hours after test conclusion.
5. Operational Life refer MIL-PRF-27: 1000 hrs. at 125 °C tested. Measurement at 24±4 hours after test conclusion.
6. External Visual refer MIL-STD-883 Method 2009: Inspect device construction, marking and workmanship.
7. Physical Dimension refer JESD22 Method JB-100: Verify physical dimensions to the applicable device detail specification.
8. Resistance to Solvents refer MIL-STD-202 Method 215: Add aqueous wash chemical - OKEM clean or equivalent.
9. Mechanical Shock refer MIL-STD-202 Method 213: Figure 1 of Method 213. Condition C.
10. Vibration refer MIL-STD-202 Method 204: 5g;s for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000 Hz.
11. Resistance to soldering Heat refer MIL-STD-202 Method 210: Condition B No pre-heat of samples. Single wave solder-procedure 2 for SMD and procedure 1 for leaded with solder within 1.5mm of device body.
12. ESD refer AEC-Q200-002 or ISO/DIS 10605: Direct contact discharge 2kV.
13. Solderability refer J-STD-002: For both Leaded & SMD. Magnification 50X. Conditions: Leaded, Method A@235°C ,category 3 ; SMD, a)Method B, 4hrs@155°C dry heat @235°C , b)Method B@215°C category 3., c)Method D category 3@260°C
14. Electrical Characterization refer spec: Show Min, Max Mean and Standard deviation at room from Min and Max temperature.
15. Flammability refer UL-94: V-0 or V-1 Acceptable.
16. Board Flex refer AEC-Q200-005: 60 sec minimum holding time.
17. Terminal Strength(SMD) refer AEC-Q200-006
18. Reflow profile recommend:

Lead-free heat endurance test



Lead-free the recommended reflow condition

